

Description

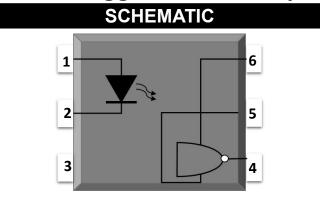
The H11LX series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a Schmitt Trigger detector in a plastic DIP6 package with different lead forming options.

Features

- High isolation 5000 VRMS
- DC input with Schmitt trigger output
- Operating temperature range 55 °C to 100 °C
- REACH & RoHS compliance
- MSL class 1
- Regulatory Approvals
 - UL UL1577
 - VDE EN60747-5-5(VDE0884-5)
 - CQC GB4943.1, GB8898
 - cUL- CSA Component Acceptance
 Service Notice No. 5A

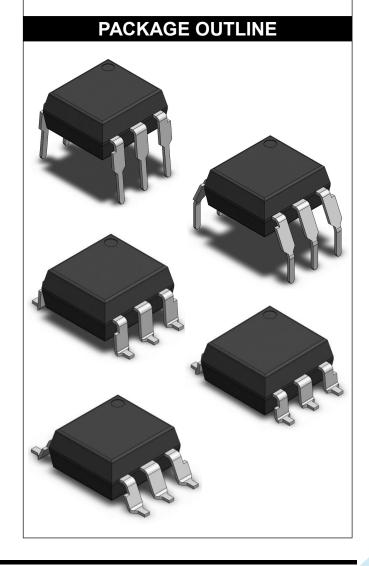
Applications

- Logic to logic isolator
- Programmable current level sensor
- Line receiver eliminate noise and transient problems
- AC to TTL conversion square wave shaping
- Digital programming of power supplies
- Interfaces computers with peripherals



PIN DEFINITION

- 1. Anode 6. VCC
- 2. Cathode 5. GND
- 3. NC 4. VOUT







	•			•		
ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	VALUE	UNIT	Note		
INPUT						
Forward Current	IF	60	mA			
Peak Transient Current	IF(trans)	1	Α	1		
Reverse Voltage	VR	6	V			
Input Power Dissipation	PI	120	mW			
OUTPUT						
Supply Voltage	VCC	3 to 16	V			
Output Voltage	VO	0 to 16	V			
Output Current	IO	50	mA			
Output Power Dissipation	РО	150	mW			
COMMON						
Total Power Dissipation	Ptot	250	mW			
Isolation Voltage	Viso	5000	Vrms	2		
Operating Temperature	Topr	-55~100	°C			
Storage Temperature	Tstg	-55~150	°C			
Soldering Temperature	Tsol	260	°C	3		
		•	•	•		

Note 1. ≤1µs P.W,300pps

Note 2. AC For 1 Minute, R.H. = $40 \sim 60\%$

Note 3. For 10 seconds



_H11LX Series

DIP6, DC Input, Schmitt Trigger Photo Coupler

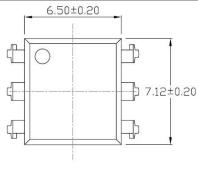
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EL	ECTRICA	L OPTIC	AL C	HARA	CTE	RIST	ICS at Ta=25°C	
PARAMET	PARAMETER		MIN.	TYP.	MAX.	UNIT	TEST CONDITION	NOTE
			I	NPUT				
Forward Voltage		VF	-	1.24	1.5	V	IF=10mA	
Reverse Cu	Reverse Current		_	-	10	μA	VR=5V	
Input Capaci	Input Capacitance		-	60	-	pF	V=0, f=1MHz	
			Ol	UTPUT	=	•		
Operation Voltage	Operation Voltage Range		3	-	15	V		
Off State Supply	Off State Supply Current		-	1.6	5	mA	IF=0mA, VCC=5V	
On State Supply	On State Supply Current		-	1.6	5	mA	IF=10mA, VCC=5V	
High Level Outp	ut Current	IOH	-	-	100	μA	IF=10mA, VCC=VO=15V	
	TRAN	SFER CHA	RACT	ERIST	ICS (Ta=-40	0 to 85°C)	
Low Level Outpu	ut Voltage	VOL	-	0.35	0.6	V	VCC=5.5V, IF=5mA, VE=2.0V, ICL=13mA	
Turn On	H11L1		-	-	1.6			
	H11L2	IFon	-	-	10	mA	VCC=5V, RL=270Ω	
Threshold Current	H11L3		-	-	5			
Turn Off Thresho	ld Current	IFoff	-	1	-	mA	VCC=5V, RL=270Ω	
Turn On T	ime	ton	-	-	4	μs		
Fall Time		tr	-	0.1	-	μs	VCC=5V, IF=IFon, RL=270Ω	
Turn Off Time		toff	-	-	4	μs		
Rise Time		tr	-	0.1	-	μs		
Data Rate			-	1	-	MHz		
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		CIO	-	0.3	1	pF	V=0, f=1MHz	

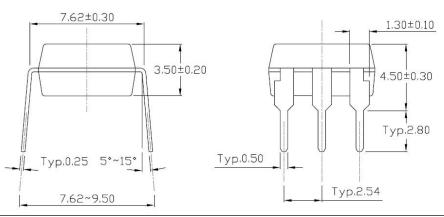


CHARACTERISTIC CURVES Fig.1 Forward Current Fig.2 Output Voltage vs. Forward Current vs. Forward Voltage I_F (mA) V_o(V) 25°C -40°C 1.0 1.3 1.4 1.5 1.6 TA (°C) Fig.4 Normalized Turn on Threshold Current **Fig.3 Normalized Turn on Threshold Current** vs. Supply Voltage vs. Ambient Temperature IF Normalized to I_{F(ON)},V_{CC}=5V T₄=25°C Normalized I_{FON} (mA) 1.1 2 1.0 8 Normalized I_{FON} (mA) 1.0 0.8 0.6 L Normalized to I_{F(ON)},V_{CC}=5V 0.6 T,=25°C 0.2 0.4 -55 20 60 8 V_{CC} (V) T₄ (°C) Fig.5 Low Level Output Voltage **Fig.6 Supply Current** vs. Load Current vs. Supply Voltage 0.4 € 0.3 (mA) =25°C T_=25°C T_A=100°C 0.0 10 I_{OL} (mA) 10 V_{cc} (V)

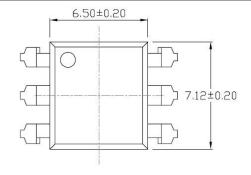


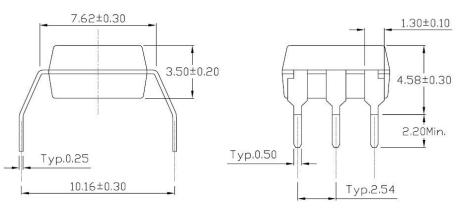
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) Standard DIP – Through Hole (DIP Type)





Gullwing (400mil) Lead Forming – Through Hole (M Type)







DIP6, DC Input, Schmitt Trigger Photo Coupler PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated) **Surface Mount Lead Forming (S Type)** 6.50±0.20 □ 7.12±0.20 7.62±0.30 1.30±0.10 3.50±0.20 Typ.0.25 4.30±0.30 Typ.0.80 Typ.0.50 Typ.0.80 10.15±0.30 Typ.2.54 Surface Mount (Low Profile) Lead Forming (SL Type) 6.50±0.20 7.12±0.20 7.62±0.30 1.30±0.10 3.50±0.20 3.60±0.30 Typ.0.25 Тур.0.10 Typ.0.50 Typ.0.80 10.15±0.30 Typ.2.54

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DIP6, DC Input, Schmitt Trigger Photo Coupler

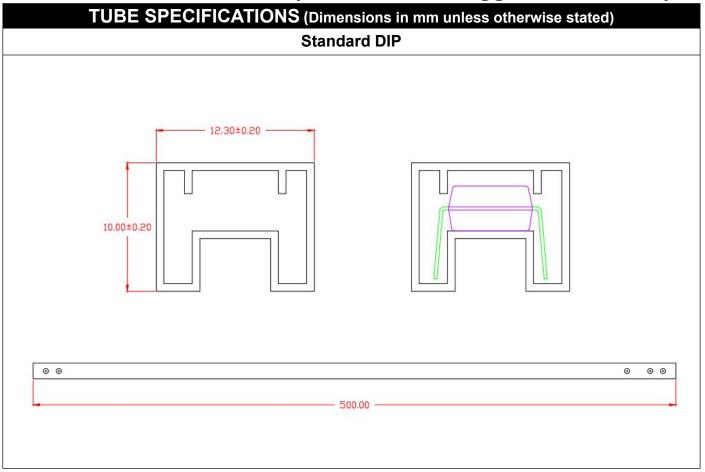
RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated) Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming 10.75 Surface Mount (Gullwing) Lead Forming 1.60 1.60 1.60 1.40



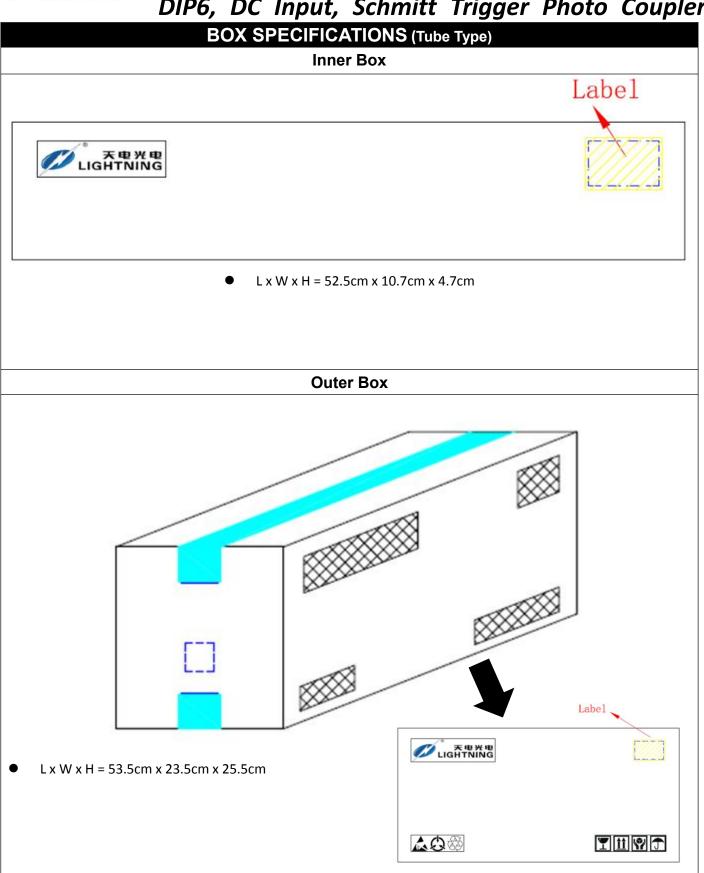


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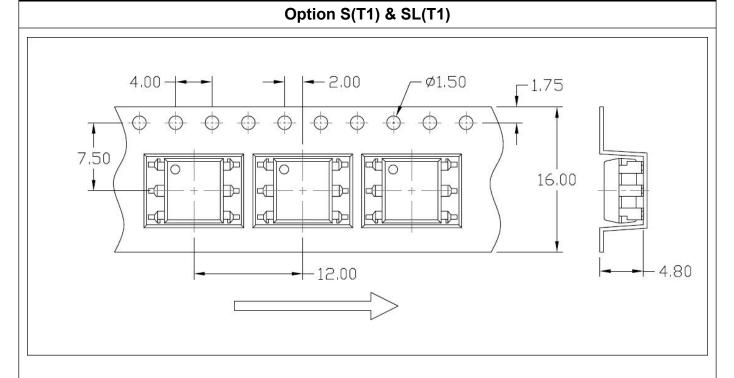




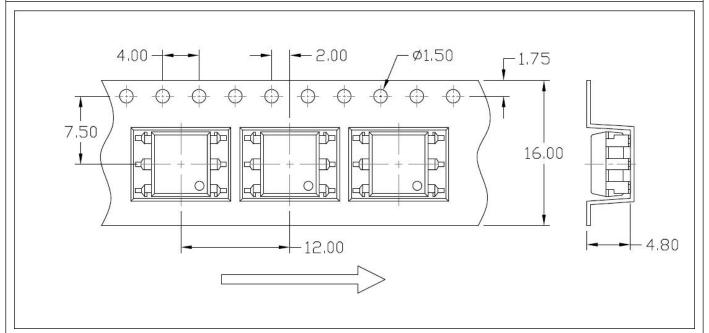




CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

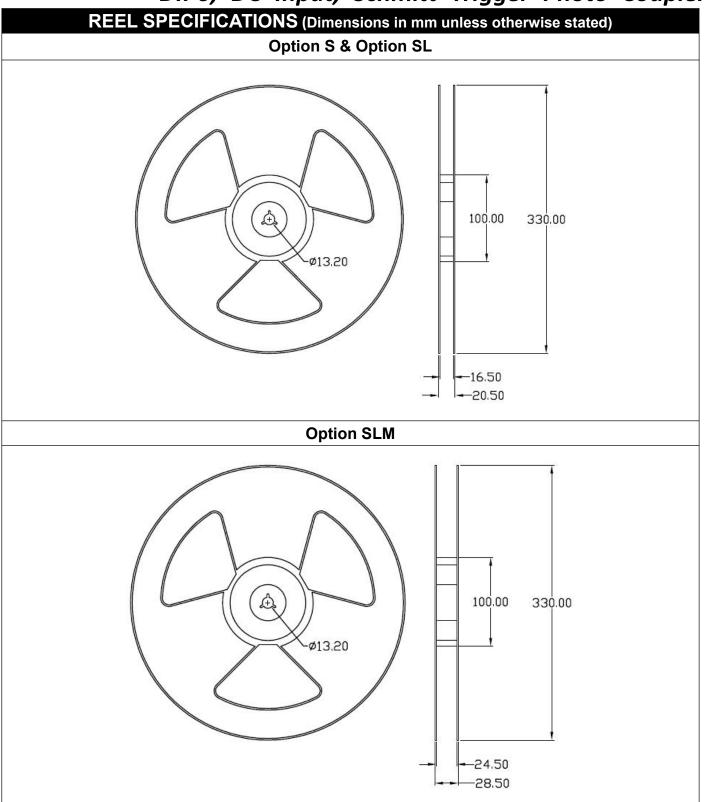


Option S(T2) & SL(T2)

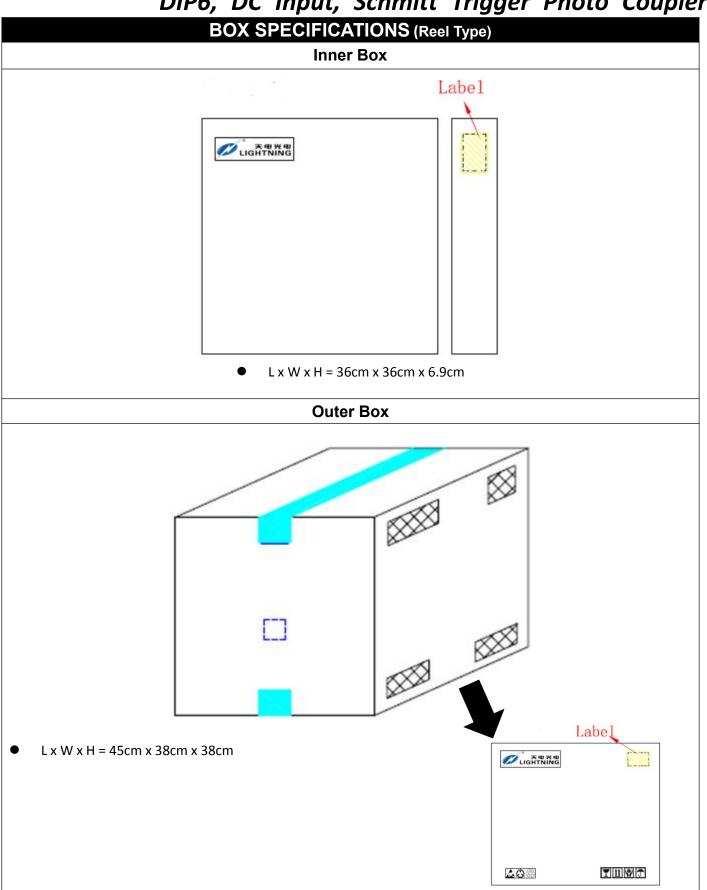








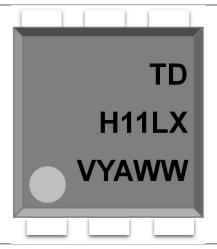






ORDERING AND MARKING INFORMATION

MARKING INFORMATION



TD : Company Abbr.

H11LX: Part Number & Rank

V : VDE Option Y : Fiscal Year

A : Manufacturing Code

WW : Work Week

ORDERING INFORMATION

H11LX(Y)(Z)-GV

TD - Company Abbr.

H11LX – Part Number (X=1/2/3)

Y – Lead Form Option (M/S/SL/None)

Z – Tape and Reel Option (T1/T2)

G – Green Option (G or None)

V – VDE Option (V or None)

LABEL INFORMATION



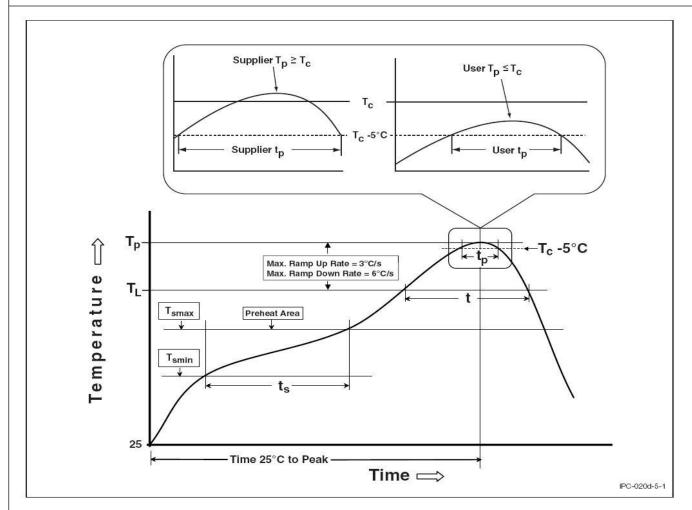
Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity – Outer box		
None	50 Units/Tube	32 Tubes/Inner box	10 Inner box/Outer box = 16k Units		
М	50 Units/Tube	28 Tubes/Inner box	10 Inner box/Outer box = 14k Units		
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units		



REFLOW INFORMATION

REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.



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